International **ICR** Rectifier

AUIRFN8401

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature •
- Fast Switching •
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant •
- Automotive Qualified *

Description

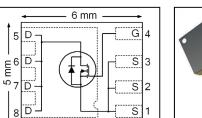
Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this product an extremely efficient and reliable device for use in Automotive and wide variety of other applications.

Applications

- Motor Control
- **Reverse Battery Protection**
- Heavy Loads

HEXFET® POWER MOSFET 40V

V _{DSS}	40V
R _{DS(on)} typ.	3.6mΩ
max	4.6mΩ
D (Silicon Limited)	84A





G	D	S
Gate	Drain	Source

Base Part Number	Package Type	Standard	Orderable Part Number	
		Form	Quantity	
AUIRFN8401	PQFN 5mm x 6mm	Tape and Reel	4000	AUIRFN8401TR

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolutemaximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units	
I _D @ T _{C(Bottom)} = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	84		
I _D @ T _{C(Bottom)} = 100°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	59	А	
I _{DM}	Pulsed Drain Current ①	336		
P _D @T _A = 25°C	Power Dissipation	4.2	W	
P _D @T _{C(Bottom)} = 25°C	Power Dissipation	63	vv	
	Linear Derating Factor	0.028	W/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) 2	69	~ I	
E _{AS} (Tested)	Single Pulse Avalanche Energy ②	93	mJ	
I _{AR}	Avalanche Current ①	See Fig. 14, 15, 22a, 22b	А	
E _{AR}	Repetitive Avalanche Energy ①		mJ	
TJ	Operating Junction and	-55 to + 175	°C	
T _{STG}	Storage Temperature Range		C	

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Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
R _{0JC} (Bottom)	Junction-to-Case ④		2.4	
R _{өJC} (Top)	Junction-to-Case ④		34	°C/W
$R_{ ext{ heta}JA}$	Junction-to-Ambient		36	C/VV
R _{θJA} (<10s)	Junction-to-Ambient		23	

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	40			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		35		mV/°C	Reference to 25° C, I _D = 1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		3.6	4.6	mΩ	V _{GS} = 10V, I _D = 50A
V _{GS(th)}	Gate Threshold Voltage	2.2	3.0	3.9	V	$V_{DS} = V_{GS}, I_D = 50 \mu A$
1	Durain to Course Lookage Current			1.0		$V_{DS} = 40V, V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current			150	μA	V _{DS} = 40V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage			100	n A	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V
R _G	Internal Gate Resistance		2.2		Ω	

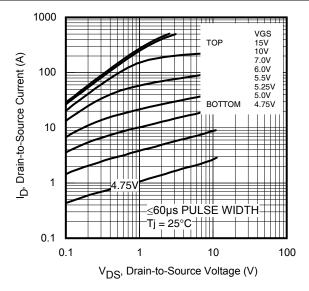
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

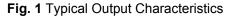
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
gfs	Forward Transconductance	144			S	V _{DS} = 10V, I _D = 50A
Q_g	Total Gate Charge		44	66		I _D = 50A
Q _{gs}	Gate-to-Source Charge		13			V _{DS} = 20V
	Gate-to-Drain ("Miller") Charge		15		nC	V _{GS} = 10V
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		29			
t _{d(on)}	Turn-On Delay Time		6.1			V _{DD} = 20V
t _r	Rise Time		13			I _D = 30A
t _{d(off)}	Turn-Off Delay Time		22		ns	R _G = 2.7Ω
t _f	Fall Time		12			V _{GS} = 10V ③
C _{iss}	Input Capacitance		2170			V _{GS} = 0V
C _{oss}	Output Capacitance		340			V _{DS} = 25V
C _{rss}	Reverse Transfer Capacitance		220		pF	f = 1.0 MHz
Coss eff. (ER)	Effective Output Capacitance (Energy Related)		422			V_{GS} = 0V, V_{DS} = 0V to 32V \odot
Coss eff. (TR)	Effective Output Capacitance (Time Related)		502			V_{GS} = 0V, V_{DS} = 0V to 32V (6)

Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
1	Continuous Source Current			04		MOSFET symbol
I _S	(Body Diode)			84	•	showing the
	Pulsed Source Current			226	A	integral reverse
I _{SM}	(Body Diode) ①			336		p-n junction diode.
V_{SD}	Diode Forward Voltage		0.9	1.3	V	T_J = 25°C, I_S = 50A, V_{GS} = 0V ③
dv/dt	Peak Diode Recovery		7.8		V/ns	T _J = 175°C, I _S = 50A, V _{DS} = 40V
+	Reverse Recovery Time		20		20	$T_{\rm J} = 25^{\circ}C$ $T_{\rm v} = 125^{\circ}C$ $V_{\rm R} = 34V$,
t _{rr}	Reverse Recovery Time		22		ns	1 - 500
0	Boyeres Bosovery Charge		12		nC	$T_J = 25^{\circ}C$ di/dt = 100 A /up 3
Q _{rr}	Reverse Recovery Charge		15			$T_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$ di/dt = 100A/µs ³
I _{RRM}	Reverse Recovery Current		1.1			$T_J = 25^{\circ}C$







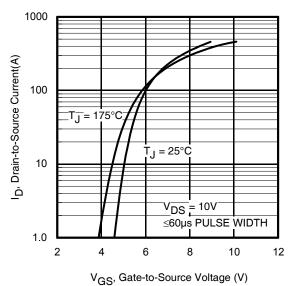


Fig. 3 Typical Transfer Characteristics

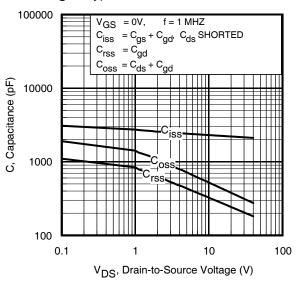


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

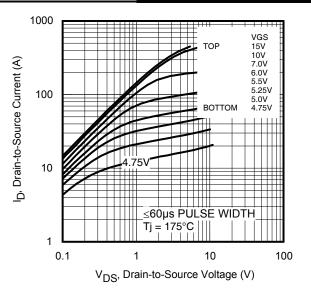
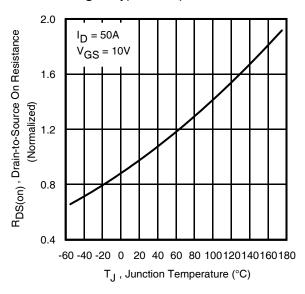
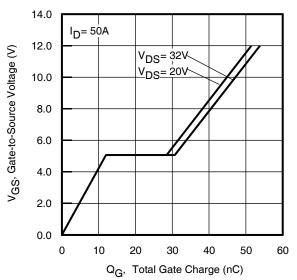
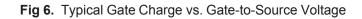


Fig. 2 Typical Output Characteristics











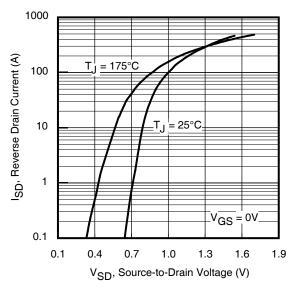


Fig. 7 Typical Source-to-Drain Diode

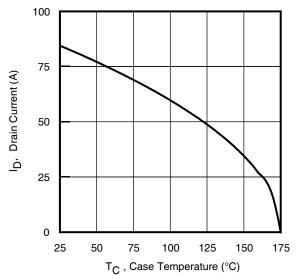


Fig 9. Maximum Drain Current vs. Case Temperature

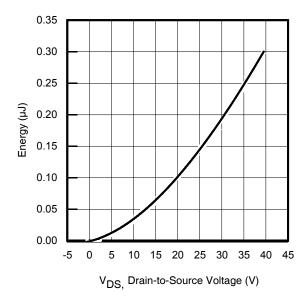


Fig 11. Typical Coss Stored Energy

4

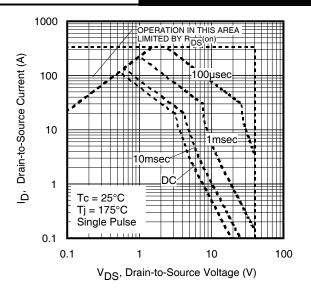


Fig 8. Maximum Safe Operating Area

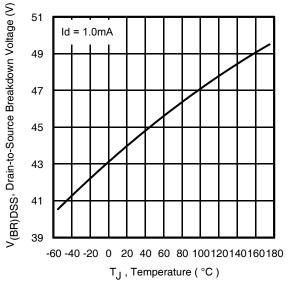


Fig 10. Drain-to-Source Breakdown Voltage

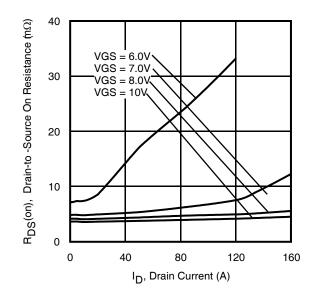
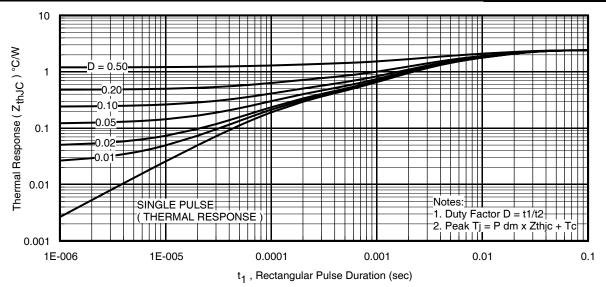


Fig 12. Typical On-Resistance vs. Drain Current





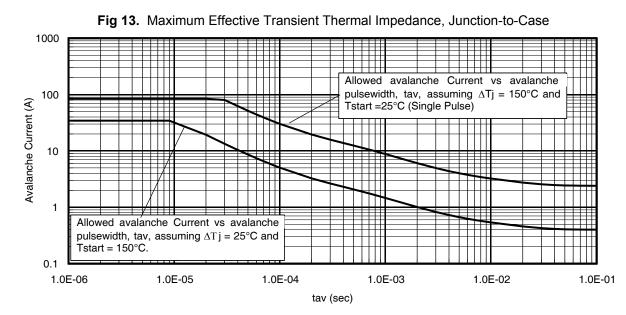


Fig 14. Typical Avalanche Current vs. Pulse Width

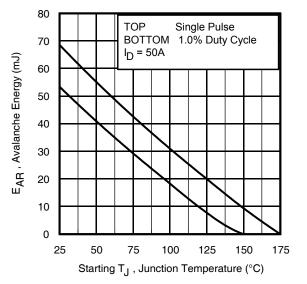


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption: Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long as T_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. PD (ave) = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. Iav = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).

tav = Average time in avalanche.

D = Duty cycle in avalanche = tav ·f

ZthJC(D, tav) = Transient thermal resistance, see Figures 13)

$$\begin{split} \textbf{P}_{D (ave)} &= 1/2 \ (\ 1.3 \cdot \textbf{BV} \cdot \textbf{I}_{av}) = \Delta T/ \ \textbf{Z}_{thJC} \\ \textbf{I}_{av} &= 2\Delta T/ \ [1.3 \cdot \textbf{BV} \cdot \textbf{Z}_{th}] \\ \textbf{E}_{AS (AR)} &= \textbf{P}_{D (ave)} \cdot \textbf{t}_{av} \end{split}$$

5



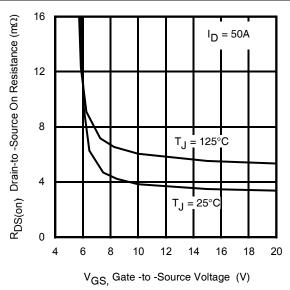


Fig 16. Typical On-Resistance vs. Gate Voltage

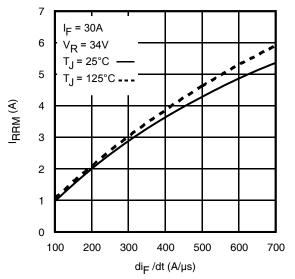


Fig. 18 - Typical Recovery Current vs. dif/dt

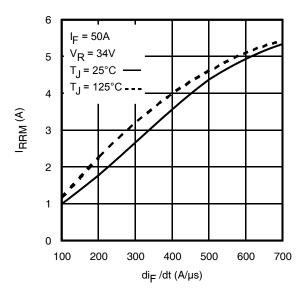


Fig. 20 - Typical Recovery Current vs. dif/dt

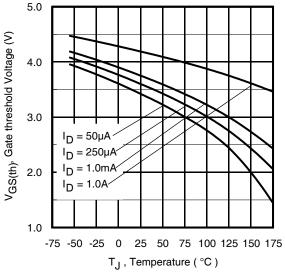


Fig 17. Threshold Voltage vs. Temperature

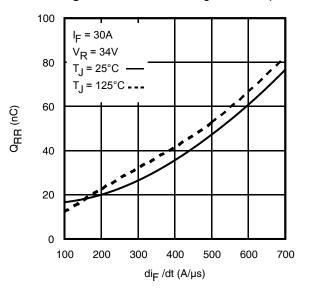


Fig. 19 - Typical Stored Charge vs. dif/dt

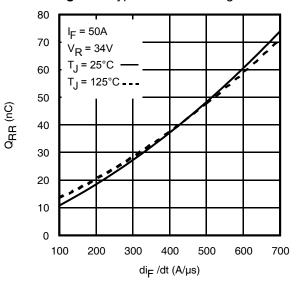
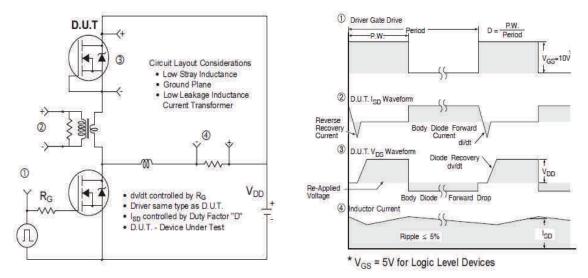
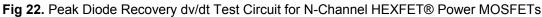


Fig. 21 - Typical Stored Charge vs. dif/dt





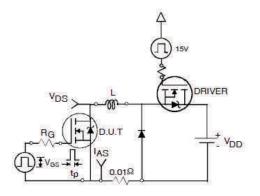


Fig 22a. Unclamped Inductive Test Circuit

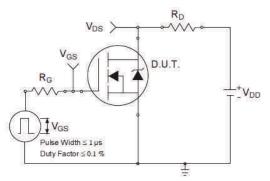


Fig 23a. Switching Time Test Circuit

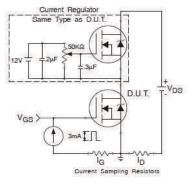


Fig 24a. Gate Charge Test Circuit

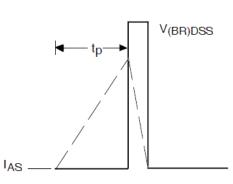


Fig 22b. Unclamped Inductive Waveforms

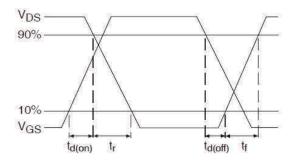
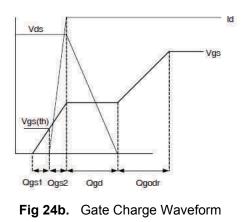
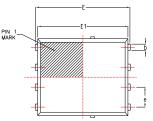


Fig 23b. Switching Time Waveforms

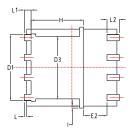


PQFN 5x6 Outline "E" Package Details





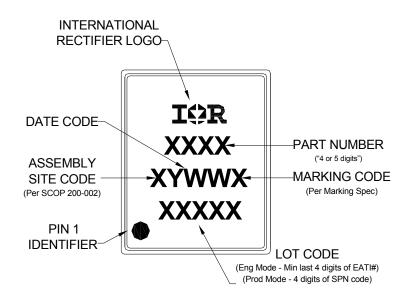
TOP VIEW



BOTTOM VIEW

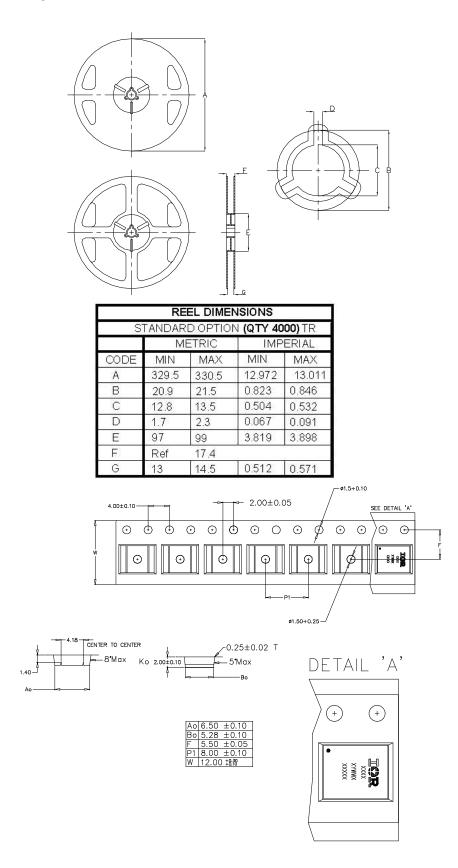
For footprint and stencil design recommendations, please refer to application note AN-1136 at <u>http://www.irf.com/technical-info/appnotes/an-1136.pdf</u> For visual inspection recommendations, please refer to application note AN-1154 at <u>http://www.irf.com/technical-info/appnotes/an-1154.pdf</u>

PQFN 5x6 Outline "E" Part Marking



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

PQFN 5x6 Outline "E" Tape and Reel



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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Qualification Information[†]

			Automotive (per AEC-Q101)			
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		PQFN 5mm x 6mm	MSL1			
	Liumen Dedu Medel	Class H1B (+/- 1000V) ^{††}				
	Human Body Model	AEC-Q101-001				
ESD	Charged Davies Medal	Class C5 (+/- 2000V) ^{††}				
Charged Device Model		AEC-Q101-005				
RoHS Compl	iant		Yes			

† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com/</u>

†† Highest passing voltage.

Notes:

- $\ensuremath{\mathbbm O}$ Repetitive rating; pulse width limited by max. junction temperature.
- ? Starting T_J = 25°C, L =0.055mH, R_G = 50 Ω , I_{AS} = 50A.
- ③ Pulse width \leq 400µs; duty cycle \leq 2%.
- B R_{θ} is measured at TJ of approximately 90°C.
- S When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994: <u>http://www.irf.com/technical-info/appnotes/an-994.pdf</u>
- © Coss eff. (TR) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 to 80% VDSS.
- © Coss eff. (ER) is a fixed capacitance that gives the same energy as Coss while VDS is rising from 0 to 80% VDSS.



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